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1742

PATENT

Atty. Dkt. No. APPM/5699/CMP/CMP/RKK

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:  
Chen, et al.

Serial No.: 10/038,066

Confirmation No.: 5741

Filed: January 3, 2002

## For: Planarization of Substrates Using Electrochemical Mechanical Polishing

MAIL STOP NON-FEE AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

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Group Art Unit: 1742

**Examiner:** Harry D. Wilkins, III

**CERTIFICATE OF MAILING**  
**37 CFR 1.8**

Dear Sir:

## **RESPONSE TO OFFICE ACTION DATED DECEMBER 4, 2003**

In response to the Office Action dated December 4, 2003, having a shortened statutory period for response set to expire on March 4, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/5699/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Specification** begin on page 2 of this paper. **Amendments to the Claims** are reflected in the listing of claims which begins on page 4 of this paper. **Remarks** begin on page 11 of this paper.